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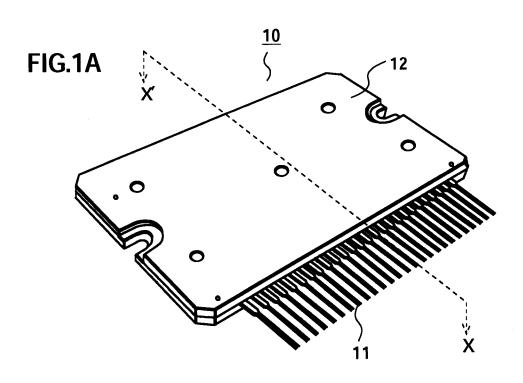
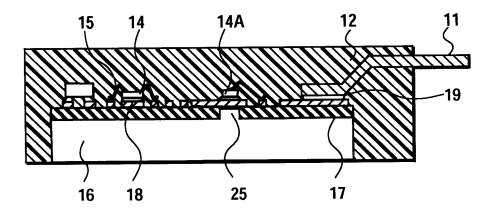


FIG.1B

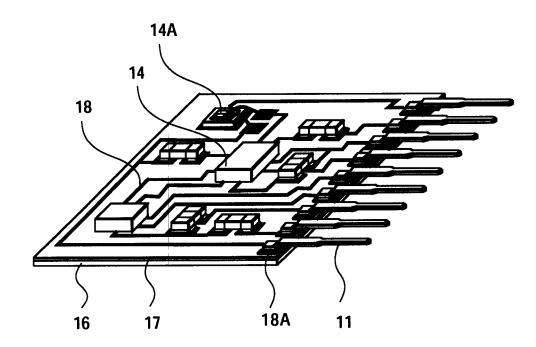


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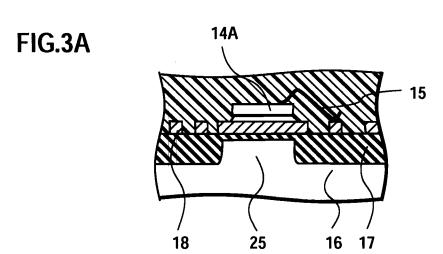
## FIG.2



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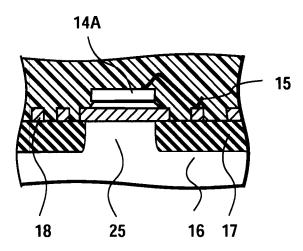
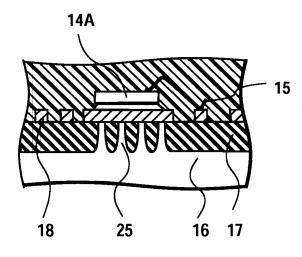


FIG.3C



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FIG.4A

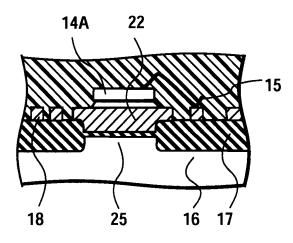


FIG.4B

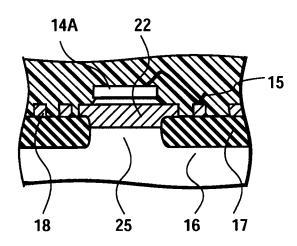
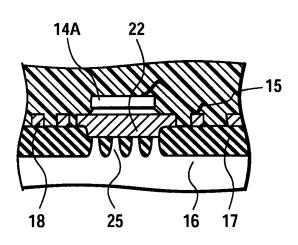


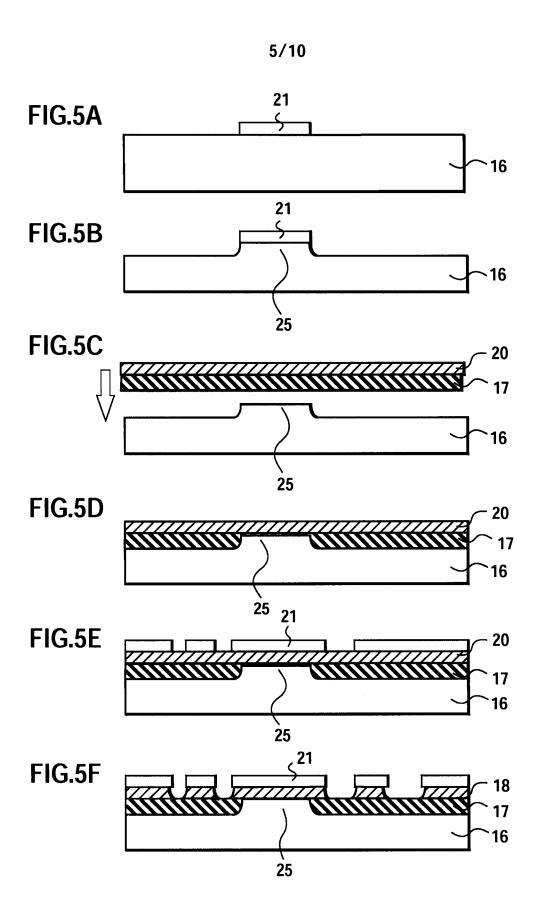
FIG.4C



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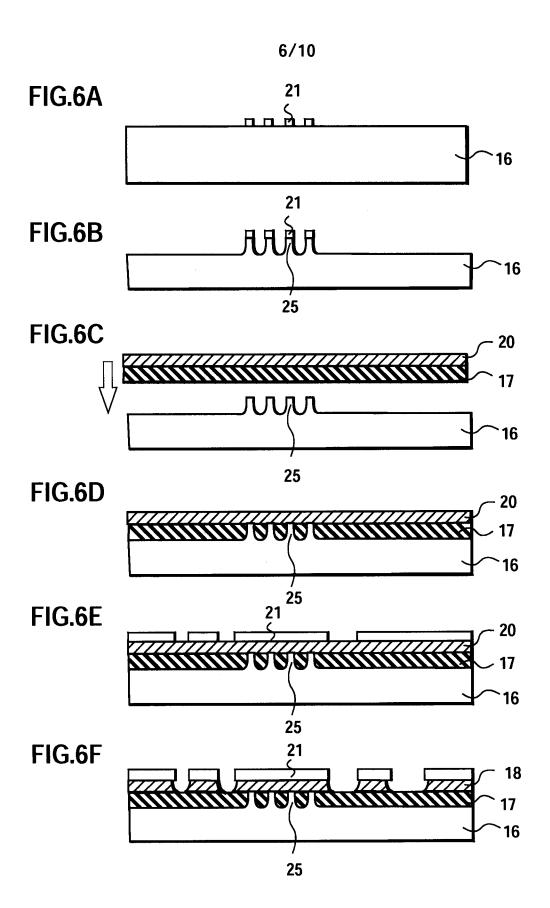
BUSOO SAI

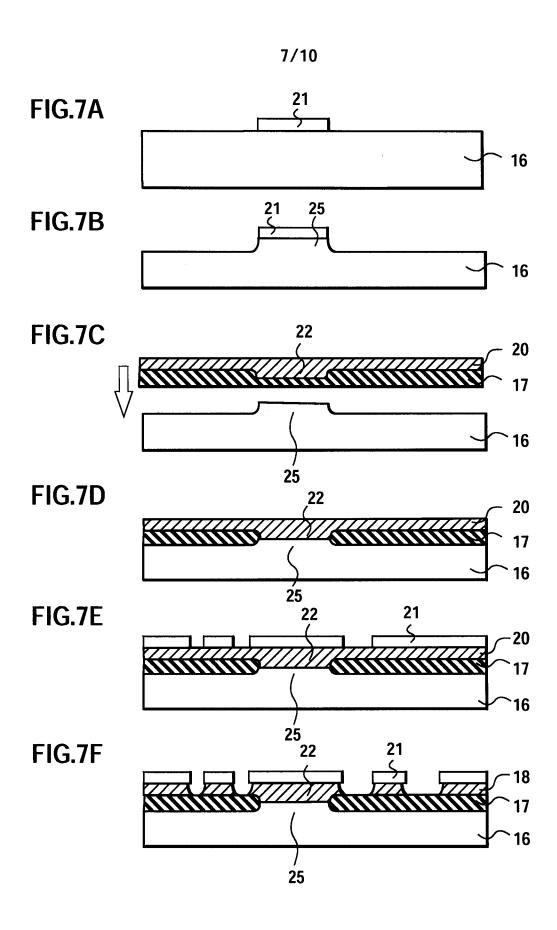


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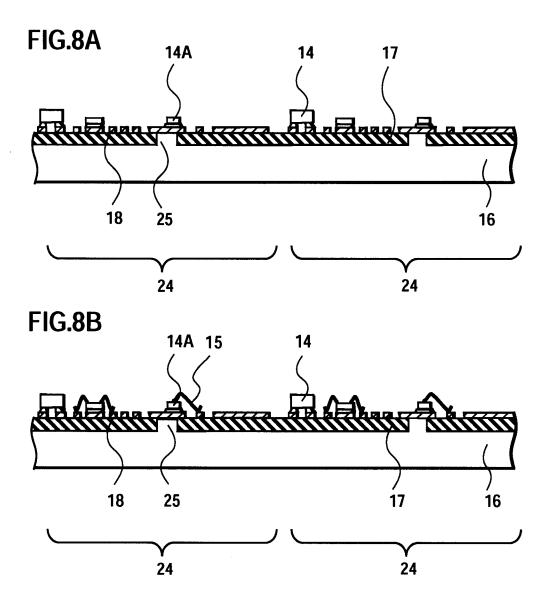
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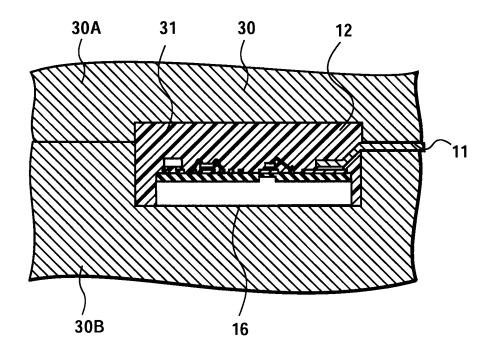


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FIG.9



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